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U.S. DEPARTMENT OF COMMERCE
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HEET

10/520263

To the Director of the U.S. Patent and Trademark Office. Please record the attached documents or the address(es) below..

1. Name of conveying party(ies)/Execution Date(s):

Reiji ARIKITA

Execution Date(s): December 10, 2004

Additional name(s) of conveying party(ies) attached?

attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies):

NAME: Shima Seiki Mfg., Ltd.

ADDRESS: 85, Sakata
Wakayama-shi, Wakayama
641-8511, Japan

3. Name of Conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☐ Other

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☐ Yes ☒ No

4. Application number(s) or patent number(s):



This document is being filed together with a new application

A. Patent Application No.(s)

PCT/JP2003/008643

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Monica Chin Kitts
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 Attorney Docket No.: 2933-159

6. Total number of applications and patents involved: 17. Total fee (37 CFR 3.41): \$ 40

- ☐ Enclosed
☒ Authorized to be charged to deposit account
☐ None required (government interest not affecting title)

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Signature

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Date

Monica Chin Kitts, Reg. No. 36,105
Name of Person SigningTotal number of pages including cover sheet, attachments and documents: 2

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PATENT
REEL: 017386 FRAME: 0628

ASSIGNMENT OF PATENT APPLICATION

WHEREAS, I/we Reiji ARIKITA, a citizen of Japan,
First Named Inventor
 residing at C/O SHIMA SEIKI MFG., LTD. 85, Sakata, Wakayama-shi, Wakayama 641-8511,
Address
 _____, a citizen of Japan,
Second named Inventor, if any
 residing at _____,
Address
 _____, a citizen of _____,
Third Named Inventor, if any
 residing at _____,
Address
 _____, a citizen of _____,
Fourth Named Inventor, if any
 residing at _____,
Address

ASSIGNOR(S), am/are the inventor(s) of an invention in (insert title) BRUSH MOUNTING STRUCTURE OF CUTTING TABLE

for which I/we have executed an application for Letters Patent of the United States,

[] of even date herewith;

(Check One) [] U.S. Serial Number _____ filed _____;
 [x] International Application No. PCT/JP2003/008643 filed 07 July 2003;

and

WHEREAS, SHIMA SEIKI MFG., LTD. 85, Sakata, Wakayama-shi, Wakayama 641-8511 Japan

Assignee

Citizenship or Corporate Situs

Address

ASSIGNEE, is desirous of obtaining the entire right, title and interest in, to and under the said invention and the said application;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to me/us in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, I/we, the said **ASSIGNOR(S)** have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said **ASSIGNEE**, its successors, legal representatives and assigns, the entire right, title and interest in, to and under the said invention, and the said application and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reexamination certificates, reissues and extensions thereof, and I/we hereby authorize and request the Commissioner of Patents of the United States, to issue all Letters Patent for said invention to the said **ASSIGNEE**, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I/WE HEREBY covenant that I/we have the full right to convey the entire interest herein assigned, and that I/we have not executed, and will not execute, any agreement in conflict herewith.

AND I/WE HEREBY further covenant and agree that I/we will communicate to said **ASSIGNEE**, its successors, legal representatives and assigns, any facts known to me/us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said **ASSIGNEE**, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention at the expense of the **ASSIGNEE**.

IN TESTIMONY WHEREOF, I/we hereunto set my/our hand(s) and seal(s) the day and year set opposite my/our signature(s).

(Reiji ARIKITA) Reiji Arikita L.S. Date December 10, 20 04

L.S. Date _____, 20 ____

L.S. Date _____, 20 ____

L.S. Date _____, 20 ____

Witness:

Name

Date

Name

Date

Foreign Inventor Sole/Joint Assignment

Page 1 of 1